

Vishay Siliconix

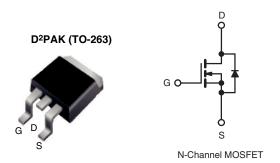
COMPLIANT

HALOGEN

FREE

D Series Power MOSFET

PRODUCT SUMMARY					
V _{DS} (V) at T _J max.	550				
R _{DS(on)} max. at 25 °C (Ω)	V _{GS} = 10 V	0.85			
Q _g (max.) (nC)	30				
Q _{gs} (nC)	4				
Q _{gd} (nC)	7				
Configuration	Single				



FEATURES

- Optimal Design
 - Low Area Specific On-Resistance
 - Low Input Capacitance (Ciss)
 - Reduced Capacitive Switching Losses
 - High Body Diode Ruggedness
 - Avalanche Energy Rated (UIS)
- Optimal Efficiency and Operation
 - Low Cost
 - Simple Gate Drive Circuitry
 - Low Figure-of-Merit (FOM): Ron x Qa
 - Fast Switching
- Material categorization: For definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Consumer Electronics
 - Displays (LCD or Plasma TV)
- Server and Telecom Power Supplies
 - SMPS
- Industrial
 - Welding
 - Induction Heating
 - Motor Drives
- Battery Chargers

ORDERING INFORMATION	
Package	D ² PAK (TO-263)
Lead (Pb)-free and Halogen-free	SiHB8N50D-GE3

ABSOLUTE MAXIMUM RATINGS (T_C	= 25 °C, unl	ess otherwis	se noted)		
PARAMETER			SYMBOL	LIMIT	UNIT
Drain-Source Voltage			V_{DS}	500	
Gate-Source Voltage				± 30	V
Gate-Source Voltage AC (f > 1 Hz)			V _{GS}	30	
Continuous Drain Current (T _J = 150 °C)	V _{GS} at 10 V	T _C = 25 °C	1-	8.7	
		T _C = 100 °C	l _D	5.5	А
Pulsed Drain Current ^a			I _{DM}	18]
Linear Derating Factor				1.25	W/°C
Single Pulse Avalanche Energy ^b			E _{AS}	29	mJ
Maximum Power Dissipation			P_{D}	156	W
Operating Junction and Storage Temperature Range			T _J , T _{stg}	- 55 to + 150	°C
Drain-Source Voltage Slope	T _J = 125 °C		-1\//-1+	24	1//20
Reverse Diode dV/dt ^d			dV/dt	0.37	- V/ns
Soldering Recommendations (Peak Temperature) ^c	for 10 s			300	°C

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature.
- b. V_{DD} = 50 V, starting T_J = 25 °C, L = 2.3 mH, R_q = 25 Ω , I_{AS} = 5 Å.
- c. 1.6 mm from case.
- d. $I_{SD} \le I_D$, starting $T_J = 25$ °C.



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THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum Junction-to-Ambient	R _{thJA}	-	62	°C/W	
Maximum Junction-to-Case (Drain)	R_{thJC}	-	0.8	C/ VV	

PARAMETER	SYMBOL	TES	TEST CONDITIONS			MAX.	UNIT
Static				<u>'</u>	l .	•	
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} = 0 V, I _D = 250 μA		500	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C, I _D = 250 μA	-	0.58	-	V/°C
Gate-Source Threshold Voltage (N)	V _{GS(th)}	V _{DS} =	$V_{DS} = V_{GS}, I_{D} = 250 \mu\text{A}$		-	5	V
Gate-Source Leakage	I _{GSS}	,	V _{GS} = ± 30 V		-	± 100	nA
Zero Gate Voltage Drain Current	I _{DSS}		$V_{DS} = 500 \text{ V}, V_{GS} = 0 \text{ V}$ $V_{DS} = 400 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 125 \text{ °C}$		-	1 10	μA
Drain-Source On-State Resistance	R _{DS(on)}	$V_{GS} = 10 \text{ V}$		_	0.70	0.85	Ω
Forward Transconductance ^a	9fs		= 20 V, I _D = 4 A	_	3	-	S
Dynamic	Jis	- 53					
Input Capacitance	C _{iss}	V 0V		<u> </u>	527	T -	
Output Capacitance	C _{oss}	┪,	$V_{GS} = 0 \text{ V}, \\ V_{DS} = 100 \text{ V},$		52	-	1
Reverse Transfer Capacitance	C _{rss}	f = 1 MHz		-	8	-	pF
Effective Output Capacitance, Energy Related ^b	C _{o(er)}	V _{DS} = 0 V to 400 V, V _{GS} = 0 V		-	46	-	
Effective Output Capacitance, Time Related ^c	C _{o(tr)}			-	64	-	
Total Gate Charge	Qg			-	15	30	
Gate-Source Charge	Q _{gs}	V _{GS} = 10 V	$V_{GS} = 10 \text{ V}$ $I_D = 4 \text{ A}, V_{DS} = 400 \text{ V}$		4	-	nC
Gate-Drain Charge	Q _{gd}				7	-	
Turn-On Delay Time	t _{d(on)}	$V_{DD} = 400 \text{ V}, I_{D} = 4 \text{ A}$ $R_{g} = 9.1 \Omega, V_{GS} = 10 \text{ V}$		-	13	26	- ns
Rise Time	t _r			-	16	32	
Turn-Off Delay Time	t _{d(off)}			-	17	34	
Fall Time	t _f			-	11	22	
Gate Input Resistance	R _g	f = 1 MHz, open drain		-	1.8	-	Ω
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	I _S	MOSFET sym showing the	MOSFET symbol		-	8	_
Pulsed Diode Forward Current	I _{SM}	integral reverse p - n junction diode		-	-	32	A
Diode Forward Voltage	V_{SD}	T _J = 25 °C, I _S = 4 A, V _{GS} = 0 V		-	-	1.2	V
Reverse Recovery Time	t _{rr}	$T_J = 25 \text{ °C, } I_F = I_S = 4 \text{ A,}$ $dI/dt = 100 \text{ A/}\mu\text{s, } V_R = 20 \text{ V}$		-	308	-	ns
Reverse Recovery Charge	Q_{rr}			-	1.8	-	μC
Reverse Recovery Current	I _{RRM}			-	11	_	Α

- a. Repetitive rating; pulse width limited by maximum junction temperature.
- b. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} . c. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

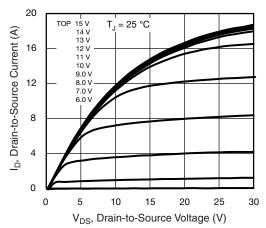


Fig. 1 - Typical Output Characteristics

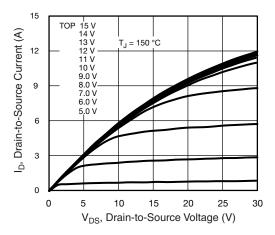


Fig. 2 - Typical Output Characteristics

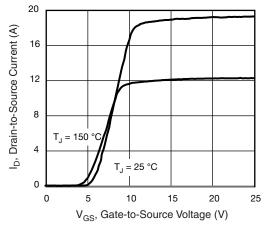


Fig. 3 - Typical Transfer Characteristics

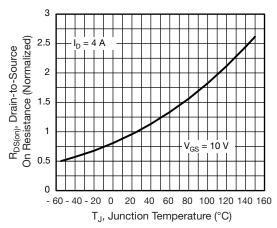


Fig. 4 - Normalized On-Resistance vs. Temperature

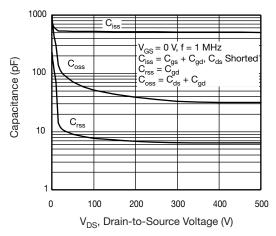


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

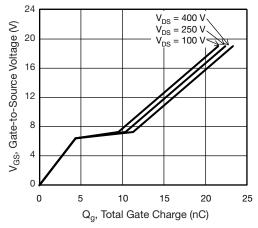


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage



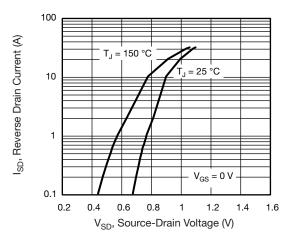


Fig. 7 - Typical Source-Drain Diode Forward Voltage

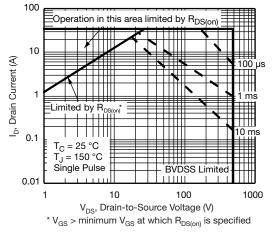


Fig. 8 - Maximum Safe Operating Area

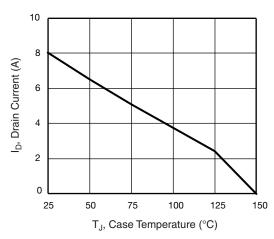


Fig. 9 - Maximum Drain Current vs. Case Temperature

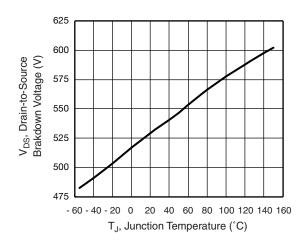


Fig. 10 - Typical Drain-to-Source Voltage vs. Temperature

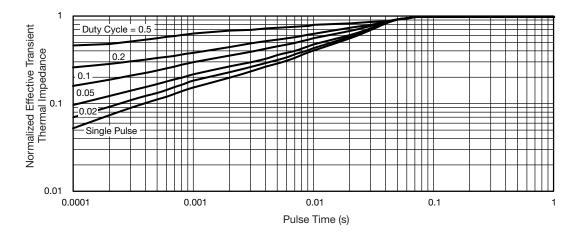


Fig. 11 - Normalized Thermal Transient Impedance, Junction-to-Case



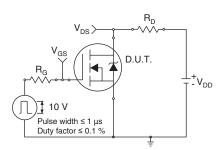


Fig. 12 - Switching Time Test Circuit

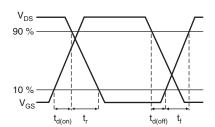


Fig. 13 - Switching Time Waveforms

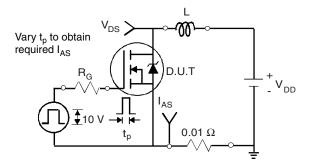


Fig. 14 - Unclamped Inductive Test Circuit

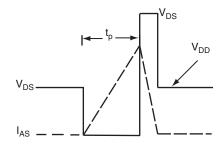


Fig. 15 - Unclamped Inductive Waveforms

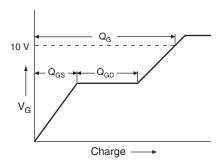


Fig. 16 - Basic Gate Charge Waveform

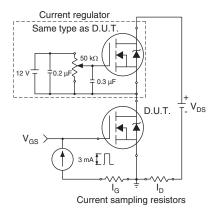
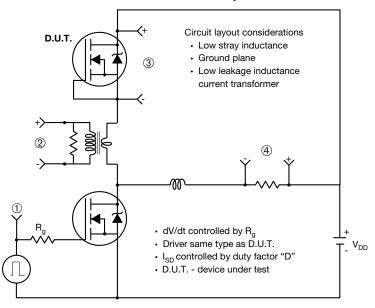


Fig. 17 - Gate Charge Test Circuit



Peak Diode Recovery dV/dt Test Circuit



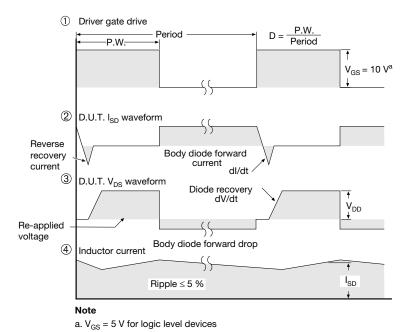


Fig. 18 - For N-Channel

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